

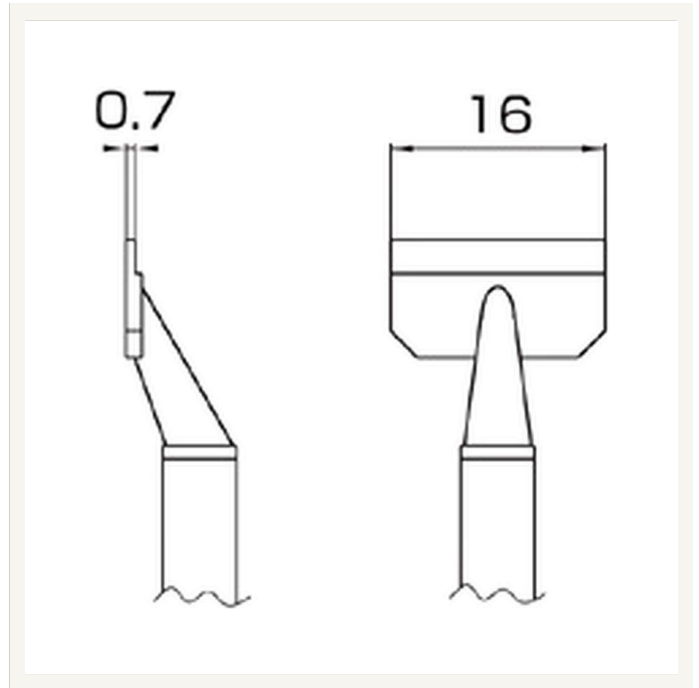
# Composite Desoldering Tip SOP 16L - Hakko T16-1009

Item no. HK-T16-1009    Manufacturer Hakko    EAN 4962615028137

Composite desoldering tip in SOP 16L format designed for use with the Hakko FM 2022 parallel desoldering tweezers. Pack contains 2 replacement tips for efficient component removal from surface-mount PCBs.

## TECHNICAL DATA

|                        |                                                            |
|------------------------|------------------------------------------------------------|
| Ausführungsklasse      | TEC                                                        |
| Country of Manufacture | Japan                                                      |
| HS-Code                | 85159080                                                   |
| Note                   | Es gibt keine Lieferung von Hakko Produkten in die Schweiz |
| Weight                 | 0.0099 kg                                                  |



## DESCRIPTION

## OVERVIEW

The Hakko T16-1009 is a composite desoldering tip engineered specifically for the FM 2022 parallel desoldering tweezers system. Designed in SOP 16L format, this tip enables precise and efficient removal of surface-mount integrated circuits and components from printed circuit boards without damaging surrounding traces or pads.

## KEY FEATURES

- SOP 16L format optimized for 16-pin small-outline packages
- Composite construction for enhanced durability and thermal performance
- Compatible exclusively with Hakko FM 2022 parallel desoldering tweezers
- Pack of 2 replacement tips for extended operational life
- Precision-engineered geometry for reliable solder joint contact
- Manufactured in Japan to Hakko quality standards

## TECHNICAL SPECIFICATIONS

|                   |                                       |
|-------------------|---------------------------------------|
| Tip Format        | SOP 16L                               |
| Compatible System | FM 2022 Parallel Desoldering Tweezers |
| Tip Material      | Composite                             |

|                   |          |
|-------------------|----------|
| Quantity per Pack | 2 pieces |
| Country of Origin | Japan    |

## APPLICATIONS

Ideal for electronics manufacturing, PCB rework, component replacement, and precision desoldering operations in laboratory and production environments. Particularly suited for removing surface-mount ICs and passive components from densely populated circuit boards.

## SCOPE OF DELIVERY

- 2 × Composite desoldering tips (SOP 16L format)